RENESAS Low Skew, 1-to-4 Multiplexed Differential/ LVCMOS-to-LVCMOS/LVTTL Fanout Buffer

DATA SHEET

General Description

The ICS8305 is a low skew, 1-to-4, Differential/ LVCMOS-to-LVCMOS/LVTTL Fanout Buffer. The ICS8305 has selectable clock inputs that accept either differential or single ended input levels. The clock enable is internally synchronized to eliminate runt pulses on the outputs during asynchronous assertion/deassertion of the clock enable pin. Outputs are forced LOW when the clock is disabled. A separate output enable pin controls whether the outputs are in the active or high impedance state.

Guaranteed output and part-to-part skew characteristics make the ICS8305 ideal for those applications demanding well defined performance and repeatability.

Features

- Four LVCMOS / LVTTL outputs, 7Ω output impedance
- Selectable differential or LVCMOS / LVTTL clock inputs
- CLK, nCLK pair can accept the following differential input levels: LVPECL, LVDS, LVHSTL, HCSL, SSTL $\,$
- LVCMOS_CLK supports the following input types: LVCMOS,
- Maximum output frequency: 350MHz
- Output skew: 35ps (maximum)
- Part-to-part skew: 700ps (maximum)
- Additive phase jitter, RMS: 0.04ps (typical)
- Power supply modes:

Core/Output

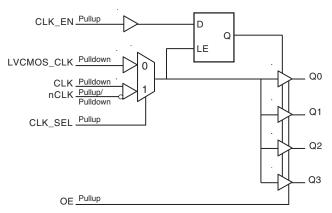
3.3V/3.3V

3.3V/2.5V

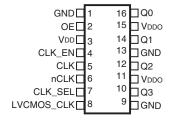
3.3V/1.8V

- 3.3V/1.5V
- 0°C to 70°C ambient operating temperature
- Available in lead-free (RoHS 6) package

Block Diagram



Pin Assignment



ICS8305

16-Lead TSSOP 4.4mm x 3.0mm x 0.925mm package body G Package **Top View**



Table 1. Pin Descriptions

Number	Name	Ту	/pe	Description
1, 9, 13	GND	Power		Power supply ground
2	OE	Input	Pullup	Output enable. When LOW, outputs are in HIGH impedance state. When HIGH, outputs are active. LVCMOS/LVTTL interface levels.
3	V_{DD}	Power		Power supply pin.
4	CLK_EN	Input	Pullup	Synchronizing clock enable. When LOW, the output clocks are disabled. When HIGH, output clocks are enabled. LVCMOS/LVTTL interface levels.
5	CLK	Input	Pulldown	Non-inverting differential clock input.
6	nCLK	Input	Pullup/ Pulldown	Inverting differential clock input. VDD/2 default when left floating.
7	CLK_SEL	Input	Pullup	Clock select input. When HIGH, selects CLK, nCLK inputs. When LOW, selects LVCMOS_CLK input. LVCMOS/LVTTL interface levels.
8	LVCMOS_CLK	Input	Pulldown	Single-ended clock input. LVCMOS/LVTTL interface levels.
10, 12, 14, 16	Q3, Q2, Q1, Q0	Output		Single-ended clock outputs. 7 Ω output impedance. LVCMOS/LVTTL interface levels.
11, 15	V_{DDO}	Power		Output supply pins.

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

Table 2. Pin Characteristics

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLUP}	Input Pullup Resistor			51		kΩ
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ
C _{PD}	Power Dissipation Capacitance (per output)			11		pF
R _{OUT}	Output Impedance			7		Ω



Function Tables

Table 3. Control Input Function Table

	Inputs					
OE	CLK_EN	CLK_SEL	Selected Source	Q0:Q3		
1	0	0	LVCMOS_CLK	Disabled; Low		
1	0	1	CLK/nCLK	Disabled; Low		
1	1	0	LVCMOS_CLK	Enabled		
1	1	1	CLK/nCLK	Enabled		
0	X	X		Hi-Z		

After CLK_EN switches, the clock outputs are disabled or enabled following a rising and falling input clock edge as shown in Figure 1.

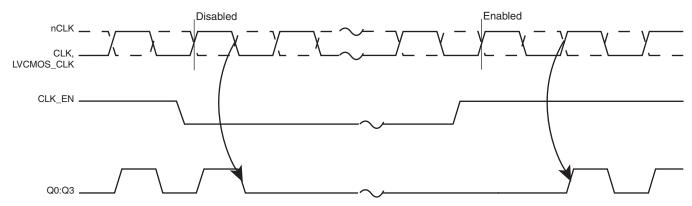


Figure 1. CLK_EN Timing Diagram



Absolute Maximum Ratings

NOTE: Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics or AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Item	Rating
Supply Voltage, V _{DD}	4.6V
Inputs, V _I	-0.5V to V _{DD} + 0.5V
Outputs, V _O	-0.5V to V _{DDO} + 0.5V
Package Thermal Impedance, θ_{JA}	89°C/W (0 lfpm)
Storage Temperature, T _{STG}	-65°C to 150°C

DC Electrical Characteristics

Table 4A. Power Supply DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$ or $1.8V \pm 0.5V$ or $1.5V \pm 5\%$, $T_A = 0$ °C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Positive Supply Voltage		3.135	3.3	3.465	V
.,			3.135	3.3	3.465	V
	Output Supply Voltage		2.375	2.5	2.625	V
V_{DDO}			1.65	1.8	1.95	V
			1.425	1.5	1.575	V
I _{DD}	Power Supply Current				21	mA
I _{DDO}	Output Supply Current				5	mA



Table 4B. LVCMOS/LVTTL DC Characteristics, $T_A = 0^{\circ}C$ to $70^{\circ}C$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V _{IH}	Input High	CLK_EN, CLK_SEL, OE		2		V _{DD} + 0.3	V
	Voltage	LVCMOS_CLK		2		V _{DD} + 0.3	V
V _{IL}	Input Low Voltage	CLK_EN, CLK_SEL, OE		-0.3		0.8	V
	voltage	LVCMOS_CLK		-0.3		1.3	V
I _{IH}	Input	CLK_EN, CLK_SEL, OE	$V_{DD} = V_{IN} = 3.465V$			5	μA
	High Current	LVCMOS_CLK	$V_{DD} = V_{IN} = 3.465V$			150	μΑ
I _{IL}	Input	CLK_EN, CLK_SEL, OE	$V_{DD} = 3.465V, V_{IN} = 0V$	-150			μA
	Low Current	LVCMOS_CLK	$V_{DD} = 3.465V, V_{IN} = 0V$	-5			μΑ
			$V_{DDO} = 3.3V \pm 5\%$	2.6			V
V	Output High Va	Itana NOTE 1	$V_{DDO} = 2.5V \pm 5\%$	1.8			V
V _{OH}	Output High Vo	itage, NOTE I	$V_{DDO} = 1.8V \pm 0.15V$	1.5			V
			$V_{DDO} = 1.5V \pm 5\%$	V _{DDO} - 0.3			V
			$V_{DDO} = 3.3V \pm 5\%$			0.5	V
V	Outrant Laur Vall	to see NOTE 4	$V_{DDO} = 2.5V \pm 5\%$			0.5	V
V_{OL}	Output Low Voltage; NOTE 1		$V_{DDO} = 1.8V \pm 0.15V$			0.4	V
			$V_{DDO} = 1.5V \pm 5\%$			0.35	V
I _{OZL}	Output Hi-Z Cur	rrent Low		-5			μΑ
I _{OZH}	Output Hi-Z Cur	rrent High				5	μΑ

NOTE 1: Outputs terminated with 50Ω to $V_{DDO}/2$. See Parameter Measurement Information, *Output Load Test Circuit diagrams*.

Table 4C. Differential DC Characteristics, $T_A = -40 \,^{\circ}\text{C}$ to $85 \,^{\circ}\text{C}$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
ı	Input High	nCLK	$V_{DD} = V_{IN} = 3.465V$			150	μΑ
IH	Current	CLK	$V_{DD} = V_{IN} = 3.465V$			150	μΑ
	Input Low	nCLK	$V_{DD} = 3.465V, V_{IN} = 0V$	-150			μΑ
I _I IL	Current	CLK	$V_{DD} = 3.465V, V_{IN} = 0V$	-5			μΑ
V _{PP}	Peak-to-Peak V NOTE 1	oltage;		0.15		1.3	V
V _{CMR}	Common Mode NOTE 1, 2	Input Voltage;		GND + 0.5		V _{DD} – 0.85	V

NOTE 1: $V_{\rm IL}$ should not be less than -0.3V. NOTE 2: Common mode input voltage is defined as $V_{\rm IH}$.



AC Electrical Characteristics

Table 5A. AC Characteristics, $V_{DD} = V_{DDO} = 3.3V \pm 5\%$, $T_A = 0$ °C to 70°C

Parameter	Symbol		Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency					350	MHz
tp _{LH}	Propagation Delay, Low to High	LVCMOS_CLK; NOTE 1A CLK/nCLK; NOTE 1B		1.75		2.75	ns
tsk(o)	Output Skew; N	IOTE 2, 6	Measured on the Rising Edge			35	ps
tsk(pp)	Part-to-Part Ske	ew; NOTE 3, 6				700	ps
tjit	Buffer Additive I refer to Additive Section, NOTE				0.04		ps
t _R / t _F	Output Rise/Fal NOTE 4	II Time;	20% to 80%	100		700	ps
odc	Output Duty Cy	ala	Ref = CLK/nCLK	45		55	%
ouc	Output Duty Cy	CIE	Ref = LVCMOS_CLK, $f \le 300$ MHz	45		55	%
t _{EN}	Output Enable	Time; NOTE 4				5	ns
t _{DIS}	Output Disable	Time; NOTE 4				5	ns

NOTE: Electrical parameters are guaranteed over the specified ambient operating temperature range, which is established when the device is mounted in a test socket with maintained transverse airflow greater than 500 lfpm. The device will meet specifications after thermal equilibrium has been reached under these conditions.

All parameters measured at $f \le 350$ MHz unless noted otherwise.

- NOTE 1A: Measured from the $V_{DD}/2$ of the input to $V_{DDO}/2$ of the output.
- NOTE 1B: Measured from the differential input crossing point to $V_{DDO}/2$ of the output.
- NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at V_{DDO}/2.
- NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at $V_{DDO}/2$.
- NOTE 4: These parameters are guaranteed by characterization. Not tested in production.
- NOTE 5: Driving only one input clock.
- NOTE 6: This parameter is defined in accordance with JEDEC Standard 65.

Table 5B. AC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 2.5V \pm 5\%$, $T_A = 0$ °C to 70°C

Parameter	Symbol		Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequen	су				350	MHz
tp _{LH}	Propagation Delay, Low to High	LVCMOS_CLK; NOTE 1A CLK/nCLK; NOTE 1B		1.8		2.9	ns
tsk(o)	Output Skew; N	OTE 2, 6	Measured on the Rising Edge			35	ps
tsk(pp)	Part-to-Part Ske	ew; NOTE 3, 6				800	ps
tjit	Buffer Additive I refer to Additive Section, NOTE				0.04		ps
t _R / t _F	Output Rise/Fal	l Time; NOTE 4	20% to 80%	100		700	ps
odc	Output Duty Cyc	ala.	Ref = CLK/nCLK	44		56	%
ouc	Output Duty Cyt	cie	Ref = LVCMOS_CLK, $f \le 300$ MHz	44		56	%
t _{EN}	Output Enable	Γime; NOTE 4				5	ns
t _{DIS}	Output Disable	Time; NOTE 4				5	ns

For NOTES, see Table 5A above.



Table 5C. AC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.15V$, $T_A = 0$ °C to 70°C

Parameter	Symbol		Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequence	су				350	MHz
tp _{LH}	Propagation Delay, Low to High	LVCMOS_CLK; NOTE 1A CLK/nCLK; NOTE 1B		1.95		3.65	ns
tsk(o)	Output Skew; NO	OTE 2, 6	Measured on the Rising Edge			35	ps
tsk(pp)	Part-to-Part Ske	w; NOTE 3, 6				900	ps
tjit	Buffer Additive F refer to Additive Section, NOTE 5				0.04		ps
t_R / t_F	Output Rise/Fall	Time; NOTE 4	20% to 80%	100		700	ps
odc	Output Duty Cyc	do	Ref = CLK/nCLK	44		56	%
ouc	Output Duty Cyc	ile.	Ref = LVCMOS_CLK, $f \le 300$ MHz	44		56	%
t _{EN}	Output Enable T	ime; NOTE 4				5	ns
t _{DIS}	Output Disable T	ime; NOTE 4				5	ns

NOTE: Electrical parameters are guaranteed over the specified ambient operating temperature range, which is established when the device is mounted in a test socket with maintained transverse airflow greater than 500 lfpm. The device will meet specifications after thermal equilibrium has been reached under these conditions.

All parameters measured at $f \le 350$ MHz unless noted otherwise.

NOTE 1A: Measured from the $V_{DD}/2$ of the input to $V_{DDO}/2$ of the output.

NOTE 1B: Measured from the differential input crossing point to V_{DDO}/2 of the output.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at V_{DDO}/2.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at $V_{DDO}/2$.

NOTE 4: These parameters are guaranteed by characterization. Not tested in production.

NOTE 5: Driving only one input clock.

NOTE 6: This parameter is defined in accordance with JEDEC Standard 65.

Table 5D. AC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.5V \pm 5\%$, $T_A = 0$ °C to 70°C

Parameter	Symbol		Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequen	ncy				350	MHz
tp _{LH}	Propagation Delay, Low to High	LVCMOS_CLK; NOTE 1A CLK/nCLK; NOTE 1B		2		4	ns
tsk(o)	Output Skew; N	IOTE 2, 6	Measured on the Rising Edge			35	ps
tsk(pp)	Part-to-Part Ske	ew; NOTE 3, 6				1	ns
tjit	Buffer Additive refer to Additive Section, NOTE				0.04		ps
t _R / t _F	Output Rise/Fal	II Time; NOTE 4	20% to 80%	200		900	ps
ada	Output Duty Ov	rolo	<i>f</i> ≤ 166MHz	45		55	%
odc	Output Duty Cy	cie	<i>f</i> > 166MHz	42		58	%
t _{EN}	Output Enable	Time; NOTE 4				5	ns
t _{DIS}	Output Disable	Time; NOTE 4				5	ns

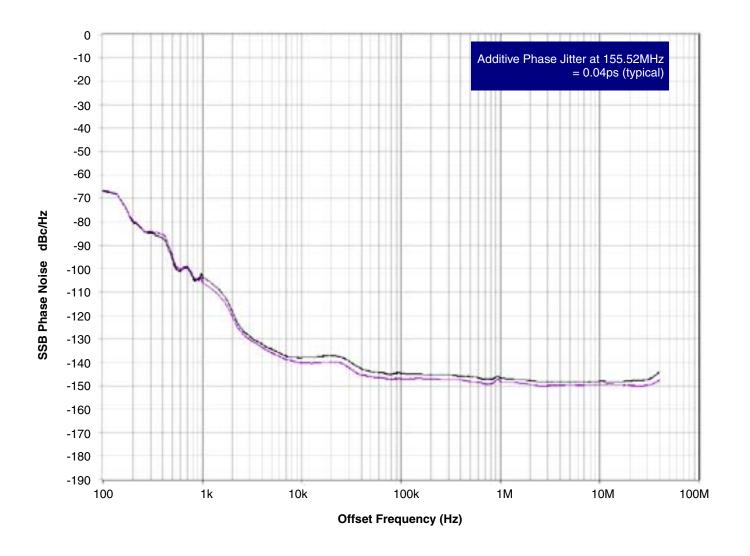
For NOTES, see Table 5C above.



Additive Phase Jitter

The spectral purity in a band at a specific offset from the fundamental compared to the power of the fundamental is called the *dBc Phase Noise*. This value is normally expressed using a Phase noise plot and is most often the specified plot in many applications. Phase noise is defined as the ratio of the noise power present in a 1Hz band at a specified offset from the fundamental frequency to the power value of the fundamental. This ratio is expressed in decibels (dBm) or a ratio

of the power in the 1Hz band to the power in the fundamental. When the required offset is specified, the phase noise is called a *dBc* value, which simply means dBm at a specified offset from the fundamental. By investigating jitter in the frequency domain, we get a better understanding of its effects on the desired application over the entire time record of the signal. It is mathematically possible to calculate an expected bit error rate given a phase noise plot.

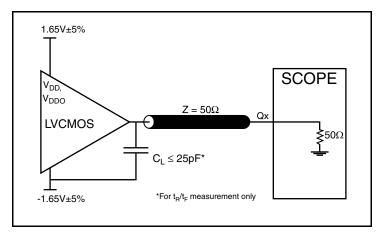


As with most timing specifications, phase noise measurements has issues relating to the limitations of the equipment. Often the noise floor of the equipment is higher than the noise floor of the device. This

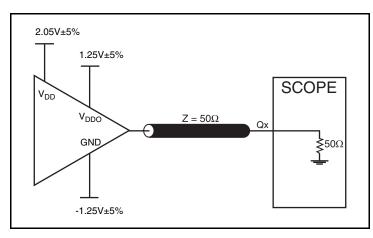
is illustrated above. The device meets the noise floor of what is shown, but can actually be lower. The phase noise is dependent on the input source and measurement equipment.



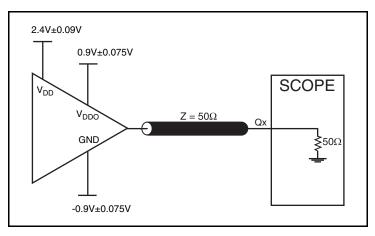
Parameter Measurement Information



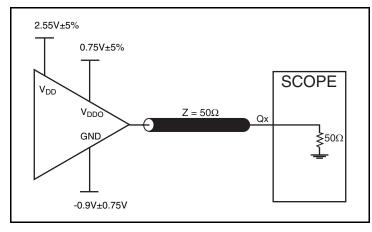
3.3V Core/3.3V LVCMOS Output Load AC Test Circuit



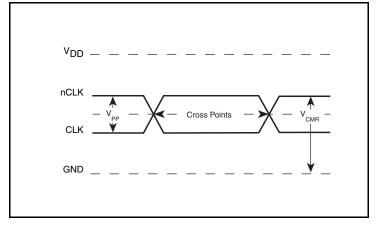
3.3V Core/2.5V LVCMOS Output Load AC Test Circuit



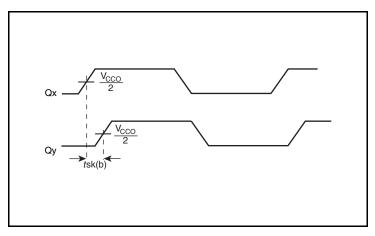
3.3V Core/1.8V LVCMOS Output Load AC Test Circuit



3.3V Core/1.5V LVCMOS Output Load AC Test Circuit



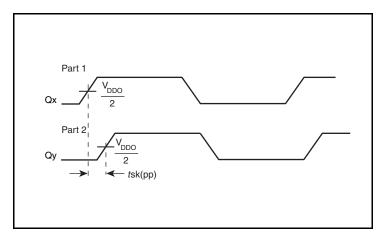
Differential Input Level

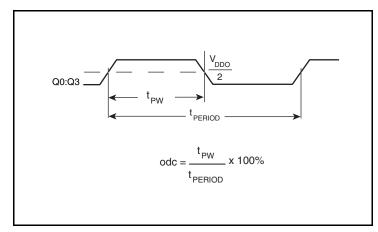


Output Skew



Parameter Measurement Information, continued

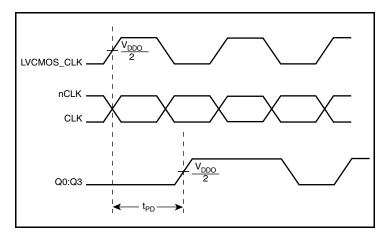




Part-to-Part Skew

Clock 20% to the term of the t

Output Duty Cycle/Pulse Width/Period



Output Rise/Fall Time

Propagation Delay



Application Information

Recommendations for Unused Input and Output Pins

Inputs:

LVCMOS_CLK Input

For applications not requiring the use of a clock input, it can be left floating. Though not required, but for additional protection, a $1k\Omega$ resistor can be tied from the LVCMOS_CLK input to ground.

CLK/nCLK Inputs

For applications not requiring the use of the differential input, both CLK and nCLK can be left floating. Though not required, but for additional protection, a $1k\Omega$ resistor can be tied from CLK to ground.

LVCMOS Control Pins

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A $1k\Omega$ resistor can be used.

Outputs:

LVCMOS Outputs

All unused LVCMOS outputs can be left floating. There should be no trace attached.

Wiring the Differential Input to Accept Single Ended Levels

Figure 2 shows how a differential input can be wired to accept single ended levels. The reference voltage $V_1 = V_{DD}/2$ is generated by the bias resistors R1 and R2. The bypass capacitor (C1) is used to help filter noise on the DC bias. This bias circuit should be located as close to the input pin as possible. The ratio of R1 and R2 might need to be adjusted to position the V_1 in the center of the input voltage swing. For example, if the input clock swing is 2.5V and $V_{DD} = 3.3V$, R1 and R2 value should be adjusted to set V_1 at 1.25V. The values below are for when both the single ended swing and V_{DD} are at the same voltage. This configuration requires that the sum of the output impedance of the driver (Ro) and the series resistance (Rs) equals the transmission line impedance. In addition, matched termination at the input will attenuate the signal in half. This can be done in one of two ways. First, R3 and R4 in parallel should equal the transmission line

impedance. For most 50Ω applications, R3 and R4 can be 100Ω . The values of the resistors can be increased to reduce the loading for slower and weaker LVCMOS driver. When using single-ended signaling, the noise rejection benefits of differential signaling are reduced. Even though the differential input can handle full rail LVCMOS signaling, it is recommended that the amplitude be reduced. The datasheet specifies a lower differential amplitude, however this only applies to differential signals. For single-ended applications, the swing can be larger, however $V_{\rm IL}$ cannot be less than -0.3V and $V_{\rm IH}$ cannot be more than $V_{\rm DD}$ + 0.3V. Though some of the recommended components might not be used, the pads should be placed in the layout. They can be utilized for debugging purposes. The datasheet specifications are characterized and guaranteed by using a differential signal.

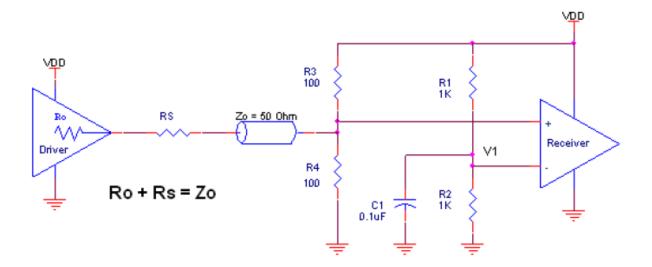


Figure 2. Recommended Schematic for Wiring a Differential Input to Accept Single-ended Levels



Differential Clock Input Interface

The CLK /nCLK accepts LVDS, LVPECL, LVHSTL, SSTL, HCSL and other differential signals. Both signals must meet the V_{PP} and V_{CMR} input requirements. *Figures 3A to 3F* show interface examples for the CLK/nCLK input driven by the most common driver types. The input interfaces suggested here are examples only. Please consult with the

vendor of the driver component to confirm the driver termination requirements. For example, in Figure 3A, the input termination applies for IDT open emitter LVHSTL drivers. If you are using an LVHSTL driver from another vendor, use their termination recommendation.

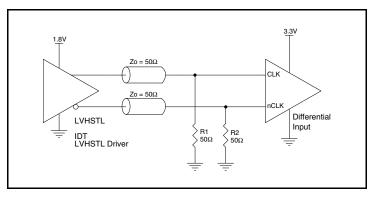


Figure 3A. CLK/nCLK Input

Driven by an IDT Open Emitter LVHSTL Driver

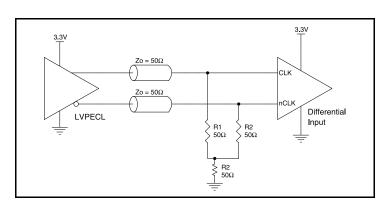


Figure 3B. CLK/nCLK Input
Driven by a 3.3V LVPECL Driver

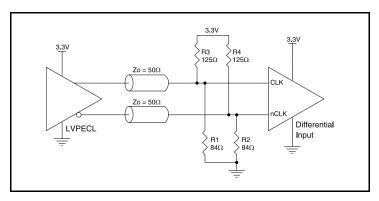


Figure 3C. CLK/nCLK Input
Driven by a 3.3V LVPECL Driver

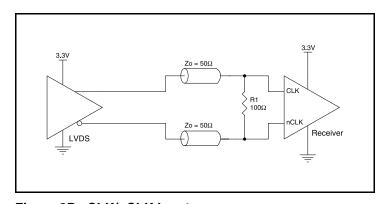


Figure 3D. CLK/nCLK Input
Driven by a 3.3V LVDS Driver

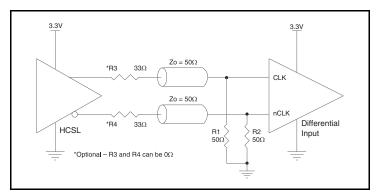


Figure 3E. CLK/nCLK Input
Driven by a 3.3V HCSL Driver

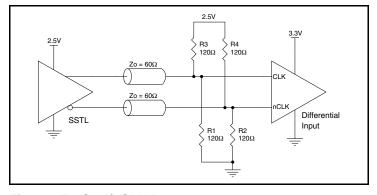


Figure 3F. CLK/nCLK Input
Driven by a 2.5V SSTL Driver



Schematic Example

This application note provides general design guide using ICS8305 LVCMOS buffer. *Figure 4* shows a schematic example of the ICS8305 LVCMOS clock buffer. In this example, the input is driven by

an LVCMOS driver. CLK_EN is set at logic low to select LVCMOS_CLK input.

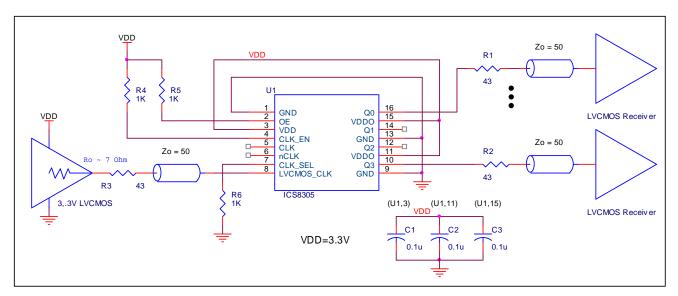


Figure 4. ICS8305 LVCMOS Clock Output Buffer Schematic Example



Reliability Information

Table 6. θ_{JA} vs. Air Flow Table for a 16 Lead TSSOP

	θ_{JA} vs. Air Flow		
Linear Feet per Minute	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	137.1°C/W	118.2°C/W	106.8°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	89.0°C/W	81.8°C/W	78.1°C/W

NOTE: Most modern PCB design use multi-layered boards. The data in the second row pertains to most designs.

Transistor Count

The transistor count for ICS8305: 459

Package Outline and Package Dimensions

Package Outline - G Suffix for 16 Lead TSSOP

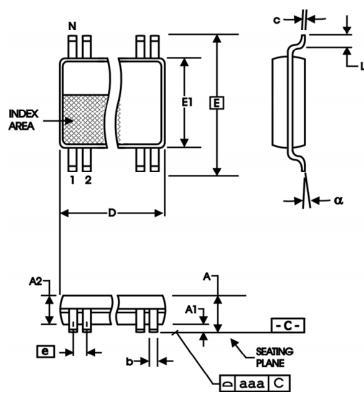


Table 7. Package Dimensions for 16 Lead TSSOP

All Dimensions in Millimeters							
Symbol	Minimum Maximum						
N	16						
Α		1.20					
A1	0.5	0.15					
A2	0.80	1.05					
b	0.19	0.30					
С	0.09	0.20					
D	4.90	5.10					
Е	6.40 Basic						
E1	4.30	4.50					
е	0.65 Basic						
L	0.45	0.75					
α	0°	8°					
aaa		0.10					

Reference Document: JEDEC Publication 95, MO-153



Ordering Information

Table 8. Ordering Information

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
8305AGLF	8305AGLF	"Lead-Free" 16 Lead TSSOP	Tube	0°C to 70°C
8305AGLFT	8305AGLF	"Lead-Free" 16 Lead TSSOP	Tape & Reel	0°C to 70°C



Revision History Sheet

Rev	Table	Page	Description of Change	Date
Α	Т8	14	Ordering Information table - corrected Part/Order Number typo from ICS88305AGT to ICS8305AGT.	1/20/04
В	T5A - T5C	5 & 6 7	Added Additive Phase Jitter to AC Characteristics Tables. Added Additive Phase Jitter Section.	2/26/04
В	T1	2	Pin Description Table - corrected CLK_EN description.	12/6/04
С	T4A T4B T5D	1 4 4 7 10 11	Features Section - added 1.5V output to Supply Mode bullet and added Lead-Free bullet. Power Supply DC Characteristics Table - added V _{DDO} 1.5V. LVCMOS DC Characteristics Table - added V _{OH} /V _{OL} 1.5V. Added 3.3V/1.5V AC Characteristics Table. Added 3.3V/1.5V Output Load AC Test Circuit Drawing. Added Recommendations for Unused Input and Output Pins. Added Lead-Free part number.	11/17/05
С	Т8	15	Ordering Information Table - added lead-free marking. Corrected non-lead free marking from ICS8305AG to 8305AG.	2/22/08
С	T5A-T5D 8	1, 12 6, 7 11 15	Updated to current datasheet format Deleted HiPerClockS references. Added Note: Electrical parameters are guaranteed to Notes Updated the 'Wiring the Differential Input to Accept Single Ended Levels' section Deleted: ICS from part numbers; quantity from shipping; LF Note; disclaimer.	9/17/12
С	Т8	1 15 17	Features Section - removed leaded part reference Ordering Information - removed leaded parts. PDN# CQ-13-02 Updated Technical Support contact email address	5/30/14



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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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